

SON Series

- Compatible with standard SOIC footprint (210 Series)
- Standard Sn/Pb and Pb-free terminations
- Superior temperature performance
- Absolute tolerances to ±0.1%
- Ratio tolerances to ±0.01%



IRC's TaNFilm® Small Outline Leadless Resistor Networks are

ideally suited for applications requiring precision, long term reliability and stability in a small area. Its monolithic construction eliminates vulnerable terminations such as solder connections. The SON package is ideal for the all surface mount production reflow techniques while still possessing all the unique qualities of our TaNFilm® thin film system. Testing has demonstrated

performance exceeding MIL-PRF-83401 Characteristic H.

Electrical Data

Package	Power Rating at 70°C		Temperature	Maximum Voltage	Noise	Substrate	Termination	
Гаскаус	Element	Network	Range	Maximum voltage	NOISE	Substrate	rennination	
8-Pad	100mW	400mW		\sqrt{PxR} (not to exceed 50V)	< -25dB	99.5% Alumina	Solder Plated Over Nickel Barrier	
14-Pad	100mW	700mW	-55°C to +150°C					
16-Pad	100mW	800mW						

Manufacturing Capabilities

	Resistance Range	Available Absolute Tolerances	Available Ratio Tolerances (Ratio to R1)	Best Absolute TCR	Tracking TCR (Track to R1)
	10Ω - 24.9Ω	CDFGJ	CDFG	±100 ppm/°C	±20 ppm/°C
	25.0Ω - 49.9Ω	CDFGJ	BCDFG	±50 ppm/°C	±10 ppm/°C
Schematic A	50Ω - 199Ω	BCDFGJ	BCDFG	±25 ppm/°C	±5 ppm/°C
Schematic A	200Ω - 999Ω	BCDFGJ	ABCDFG	±25 ppm/°C	±5 ppm/°C
	1.0K - 25.0K	BDFGJ	TQABDFG	±25 ppm/°C	±5 ppm/°C
	25.1K - 100K	BDFGJ	ABDFG	±25 ppm/°C	±5 ppm/°C
	10Ω - 24.9Ω	CDFGJ	DFG	±100 ppm/°C	±25ppm/°C
Cohomotio D	25Ω - 49.9Ω	CDFGJ	CDFG	±50 ppm/°C	±15ppm/°C
Schematic B	50Ω - 199Ω	BCDFGJ	BCDFG	±25 ppm/°C	±10ppm/°C
	200Ω - 50ΚΩ	BCDFGJ	ABCDFG	±25 ppm/°C	±5ppm/°C

General Note

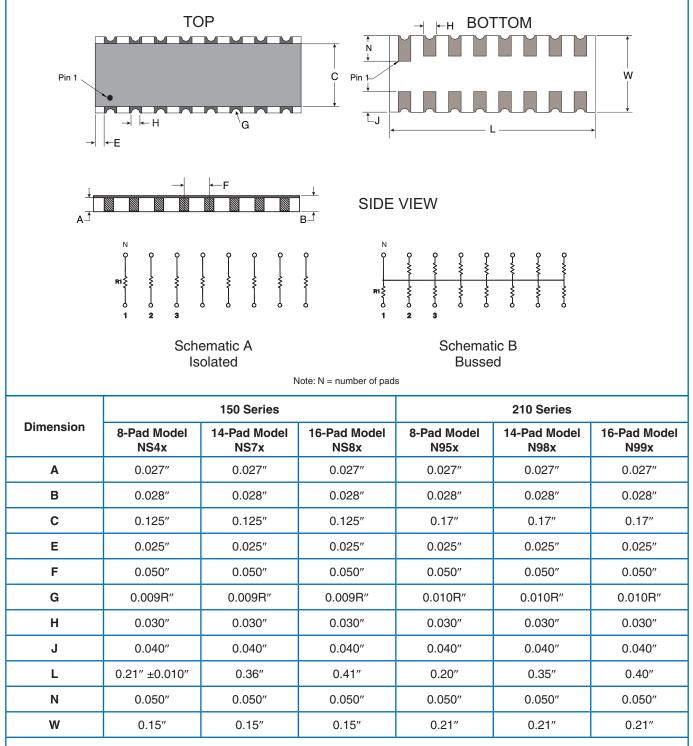
IRC reserves the right to make changes in product specification without notice or liability. All information is subject to IRC's own data and is considered accurate at time of going to print.







Physical Data



Tolerances unless noted otherwise: .XXX is ±0.005"

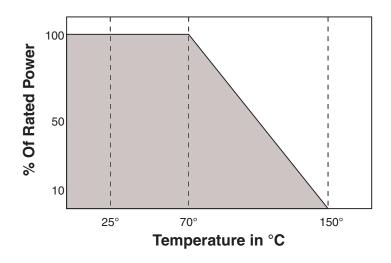
.XX is ±0.010"



Environmental Data

Environmental Test	Test Method	Characteristic K Limits (∆R)	Characteristic H Limits (∆R)	TaNFilm® Maximum ∆R	TaNFilm [®] Typical ∆R
Thermal Shock And Power Conditioning	MIL-PRF-83401	±0.7%	±0.5%	±0.1%	±0.02%
Low Temperature Operation	MIL-PRF-83401	±0.25%	±0.1%	±0.05%	±0.02%
Short-time Overload	MIL-PRF-83401	±0.25%	±0.1%	±0.05%	±0.02%
Resistance To Bonding Exposure	MIL-PRF-914	±0.25%	±0.25%	±0.1%	±0.02%
Moisture Resistance	MIL-PRF-83401	±0.5%	±0.5%	±0.1%	±0.03%
Shock	MIL-PRF-83401	±0.25%	±0.25%	±0.1%	±0.03%
Vibration	MIL-PRF-83401	±0.25%	±0.25%	±0.1%	±0.03%
Life	MIL-PRF-83401	±0.5%	±0.5%	±0.1%	±0.03%
High Temperature Exposure	MIL-PRF-83401	±0.5%	±0.2%	±0.1%	±0.03%
Low Temperature Storage	MIL-PRF-83401	±0.25%	±0.1%	±0.05%	±0.01%

Power Derating Curve





Ordering Data

Prefix	1002 -	F B
Model	:	
NS4A: 8-pad, 0.150" wide, schematic A, with 60/40 Sn/Pb terminations	•	• •
NS4ALF: 8-pad, 0.150" wide, schematic A, with 100% matter tin, Pb-free terminations	:	
NS4AE: 8-pad, 0.150° wide, schematic B, with 60/40 Sn/Pb terminations		• •
	•	
NS4BLF: 8-pad, 0.150° wide, schematic B, with 100% matte tin, Pb-free terminations		
NS7A: 14-pad, 0.150" wide, schematic A, with 60/40 Sn/Pb terminations	•	• •
NS7ALF: 14-pad, 0.150" wide, schematic A, with 100% matte tin, Pb-free terminations	:	
NS7B: 14-pad, 0.150" wide, schematic B, with 60/40 Sn/Pb terminations	•	•
NS7BLF: 14-pad, 0.150" wide, schematic B, with 100% matte tin, Pb-free terminations	:	
NS8A: 16-pad, 0.150" wide, schematic A, with 60/40 Sn/Pb terminations	•	• •
NS8ALF: 16-pad, 0.150° wide, schematic A, with 100% matte tin, Pb-free terminations	:	
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NS8B: 16-pad, 0.150" wide, schematic B, with 60/40 Sn/Pb terminations		
NS8BLF: 16-pad, 0.150" wide, schematic B, with 100% matte tin, Pb-free terminations	:	
	•	· · · · ·
N959: 8-pad, 0.210" wide, schematic A, with 60/40 Sn/Pb terminations	:	
N959LF: 8-pad, 0.210" wide, schematic A, with 100% matte tin, Pb-free terminations	•	•
N954: 8-pad, 0.210" wide, schematic B, with 60/40 Sn/Pb terminations		
N954LF: 8-pad, 0.210" wide, schematic B, with 100% matte tin, Pb-free terminations	•	· • •
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N989: 14-pad, 0.210" wide, schematic A, with 60/40 Sn/Pb terminations	•	•
N989LF: 14-pad, 0.210" wide, schematic A, with 100% matte tin, Pb-free terminations	:	
N987: 14-pad, 0.210" wide, schematic B, with 60/40 Sn/Pb terminations		•
N987LF: 14-pad, 0.210" wide, schematic B, with 100% matte tin, Pb-free terminations	:	
N999: 16-pad, 0.210" wide, schematic A, with 60/40 Sn/Pb terminations	•	• •
N999LF: 16-pad, 0.210" wide, schematic A, with 100% matte tin, Pb-free terminations	:	
N998: 16-pad, 0.210" wide, schematic B, with 60/40 Sn/Pb terminations		· · · · ·
N998LF: 16-pad, 0.210" wide, schematic B, with 100% matter tin, Pb-free terminations		
N996LF. 16-pad, 0.210 wide, schematic B, with 100% matterin, Fb-hee terminations		
TOD 0-4-		
TCR Code		
01 = ±100ppm/°C Commercial Grade		
02 = ±50ppm/°C Commercial Grade		· · · ·
03 = ±25ppm/°C Commercial Grade		
04 = ±300ppm/°C Military Screened Characteristic M*		•
05 = ±100ppm/°C Military Screened Characteristic K*	•	•
06 = ±50ppm/°C Military Screened Characteristic H*	:	
07 = ±25ppm/°C Military Screened Characteristic H*	•	•
	:	
Resistance Code · · · · · · · · · · · · · · · · · · ·	• • • •	•
4-Digit resistance code		
Ex: $1002 = 10K\Omega$; $49R9 = 49.9\Omega$		• •
Absolute Tolerance Code · · · · · · · · · · · · · · · · · · ·	• • • • • • • •	••••
$J = \pm 5\%; G = \pm 2\%; F = \pm 1\%; D = \pm 0.5\%; C = \pm 0.25\%; B = \pm 0.1\%$		•
		:
Optional R1 Ratio Tolerance Code	•••••	• • • • • • • •
$F = \pm 1\%$; $D = \pm 0.5\%$; $B = \pm 0.1\%$; $A = \pm 0.05\%$; $Q = \pm 0.02\%$; $T = \pm 0.01\%$		

*Special Notes:

SON NSxx series screened per Group A MIL-PRF-55342 SON N9xx series screened per Group A MIL-PRF-83401

For additional information or to discuss your specific requirements, please contact our Applications Team using the contact details below.